Voltage Regulator - CMOS, Low Dropout
300 mA

NCV8114

The NCV8114 is 300 mA LDO that provides the engineer with a very stable, accurate voltage with low noise suitable for space constrained, noise sensitive applications. In order to optimize performance for battery operated portable applications, the NCV8114 employs the dynamic quiescent current adjustment for very low I_Q consumption at no−load.

Features

- Operating Input Voltage Range: 1.7 V to 5.5 V
- Available in Fixed Voltage Options: 0.9 V to 3.6 V Contact Factory for Other Voltage Options
- Very Low Quiescent Current of Typ. 50 μA
- Standby Current Consumption: Typ. 0.1 μA
- Low Dropout: 135 mV Typical at 300 mA
- ±1% Accuracy at Room Temperature
- High Power Supply Ripple Rejection: 75 dB at 1 kHz
- Thermal Shutdown and Current Limit Protections
- Stable with a 1 μF Ceramic Output Capacitor
- Available in TSOP Package
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applicaitons

- Parking Camera Modules
- Wireless Handsets, Wireless LAN, Bluetooth®, Zigbee®
- Automotive Infotainment Systems
- Other Battery Powered Applications

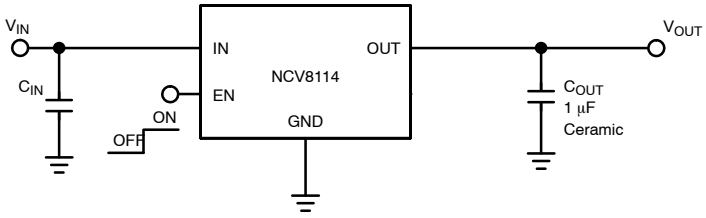
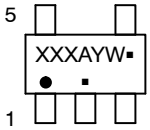


Figure 1. Typical Application Schematic



TSOP−5
SN SUFFIX
CASE 483

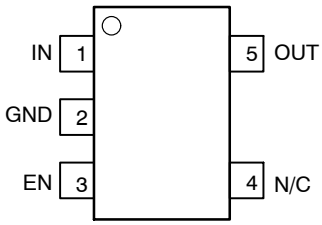
MARKING DIAGRAM



XXX = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week
▪ = Pb−Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



(Top View)

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 11 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 11.

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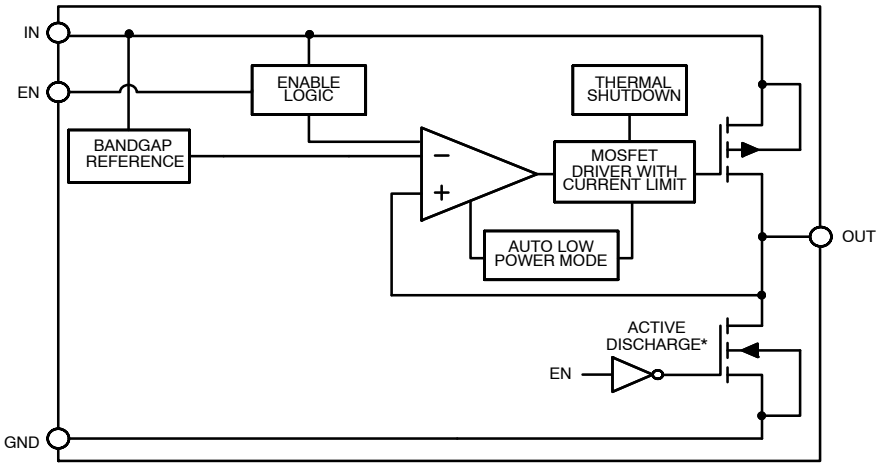

*Active output discharge function is present only in NCV8114ASNyyyTCG devices. yyy denotes the particular V_{OUT} option.

Figure 2. Simplified Schematic Block Diagram

PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
5	OUT	Regulated output voltage pin. A small ceramic capacitor with minimum value of 1 μF is needed from this pin to ground to assure stability.
2	GND	Power supply ground.
3	EN	Driving EN over 0.9 V turns on the regulator. Driving EN below 0.4 V puts the regulator into shutdown mode.
1	IN	Input pin. A small capacitor is needed from this pin to ground to assure stability.
4	N/C	Not connected. This pin can be tied to ground to improve thermal dissipation.

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V_{IN}	−0.3 V to 6 V	V
Output Voltage	V_{OUT}	−0.3 V to V_{IN} + 0.3 V or 6 V	V
Enable Input	V_{EN}	−0.3 V to V_{IN} + 0.3 V or 6 V	V
Output Short Circuit Duration	t_{SC}	∞	s
Maximum Junction Temperature	$T_{J(MAX)}$	150	°C
Operating Ambient Temperature	T_A	−40 to 125	°C
Storage Temperature	T_{STG}	−55 to 150	°C
ESD Capability, Human Body Model (Note 2)	ESD_{HBM}	2000	V
ESD Capability, Machine Model (Note 2)	ESD_{MM}	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.
2. This device series incorporates ESD protection and is tested by the following methods:
   ESD Human Body Model tested per EIA/JESD22−A114,
   ESD Machine Model tested per EIA/JESD22−A115,
   Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

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THERMAL CHARACTERISTICS (Note 3)

Rating	Symbol	Value	Unit
Thermal Characteristics, TSOP−5 Thermal Resistance, Junction−to−Air	$R_{\theta JA}$	259.9	°C/W

3. Single component mounted on 1 oz, FR 4 PCB with 645 mm^2 Cu area.

RECOMMENDED OPERATING CONDITIONS

Rating	Symbol	Min	Typ	Max	Unit
Input Voltage	V_{IN}	1.7		5.5	V
Junction Temperature	T_J	−40		+125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS

$−40°C \le T_J \le 125°C$; $V_{IN} = V_{OUT(NOM)} + 1$ V for V_{OUT} options greater than 1.5 V. Otherwise V_{IN} = 2.5 V, whichever is greater; I_{OUT} = 1 mA, $C_{IN} = C_{OUT}$ = 1 μF, unless otherwise noted. V_{EN} = 0.9 V. Typical values are at T_J = +25°C. Min./Max. are for T_J = −40°C and T_J = +125°C respectively (Note 4).

Parameter	Test Conditions		Symbol	Min	Typ	Max	Unit
Operating Input Voltage			V_{IN}	1.7		5.5	V
Output Voltage Accuracy	−40°C ≤ T_J ≤ 125°C	$V_{OUT} \le 2.0$ V	V_{OUT}	−40		+50	mV
		$V_{OUT} > 2.0$ V		−2		+3	%
Line Regulation	V_{OUT} + 0.5 V ≤ V_{IN} ≤ 5.5 V ($V_{IN} \ge$ 1.7 V)		Reg_{LINE}		0.01	0.1	%/V
Load Regulation	I_{OUT} = 1 mA to 300 mA		Reg_{LOAD}		28	45	mV
Load Transient	I_{OUT} = 1 mA to 300 mA or 300 mA to 1 mA in 1 μs, C_{OUT} = 1 μF		$Tran_{LOAD}$		−50/ +30		mV
Dropout Voltage (Note 5)	I_{OUT} = 300 mA	V_{OUT} = 1.5 V	V_{DO}		380	500	mV
		V_{OUT} = 1.85 V			260	370	
		V_{OUT} = 2.8 V			170	270	
		V_{OUT} = 3.0 V			160	260	
		V_{OUT} = 3.1 V			155	250	
		V_{OUT} = 3.3 V			150	240	
Output Current Limit	V_{OUT} = 90% $V_{OUT(nom)}$		I_{CL}	300	600		mA
Ground Current	I_{OUT} = 0 mA		I_Q		50	95	μA
Shutdown Current	$V_{EN} \le 0.4$ V, V_{IN} = 5.5 V		I_{DIS}		0.01	1	μA
EN Pin Threshold Voltage High Threshold Low Threshold	 V_{EN} Voltage increasing V_{EN} Voltage decreasing		 V_{EN_HI} V_{EN_LO}	 0.9		 0.4	V
EN Pin Input Current	V_{EN} = 5.5 V		I_{EN}		0.3	1.0	μA
Power Supply Rejection Ratio	V_{IN} = 4.3 V, V_{OUT} = 3.3 V I_{OUT} = 10 mA	f = 1 kHz	PSRR		75		dB
Output Noise Voltage	V_{IN} = 2.5 V, V_{OUT} = 1.8 V, I_{OUT} = 150 mA f = 10 Hz to 100 kHz		V_N		70		μV_{rms}
Thermal Shutdown Temperature	Temperature increasing from T_J = +25°C		T_{SD}		160		°C
Thermal Shutdown Hysteresis	Temperature falling from T_{SD}		T_{SDH}		20		°C
Active Output Discharge Resistance	V_{EN} < 0.4 V, Version A only		R_{DIS}		100		Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Performance guaranteed over the indicated operating temperature range by design and/or characterization. Production tested at $T_J = T_A$ = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
5. Characterized when V_{OUT} falls 100 mV below the regulated voltage at $V_{IN} = V_{OUT(NOM)} + 1$ V.

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TYPICAL CHARACTERISTICS

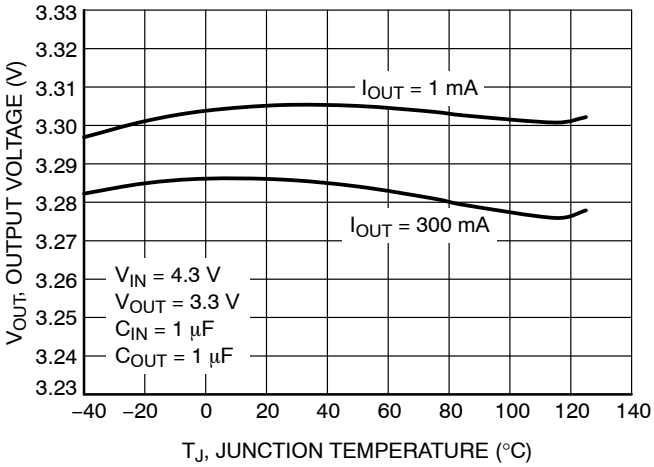

Figure 3. Output Voltage vs. Temperature – V_{OUT} = 3.3 V

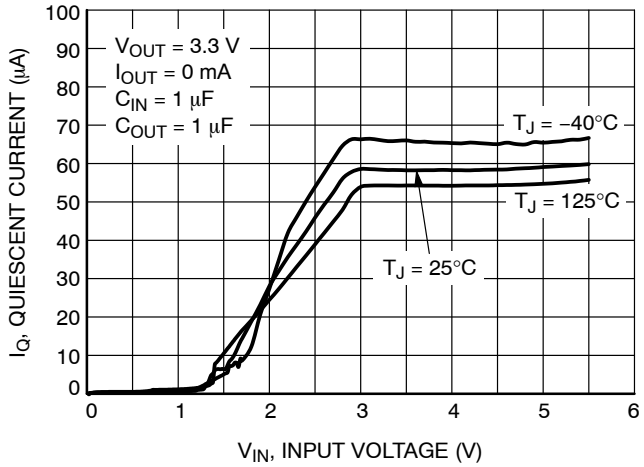

Figure 4. Quiescent Current vs. Input Voltage

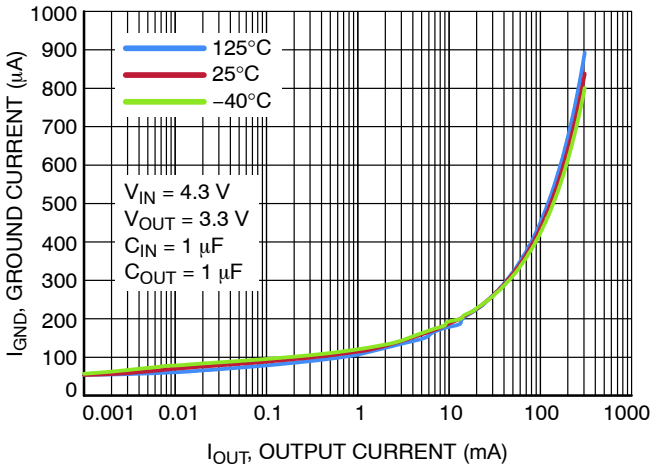

Figure 5. Ground Current vs. Output Current

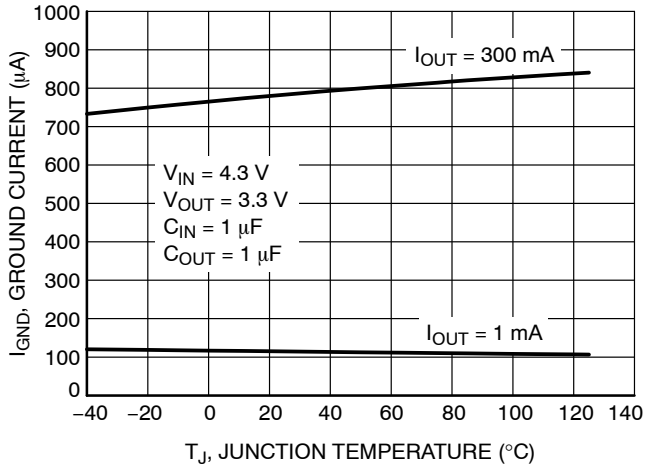

Figure 6. Ground Current vs. Temperature

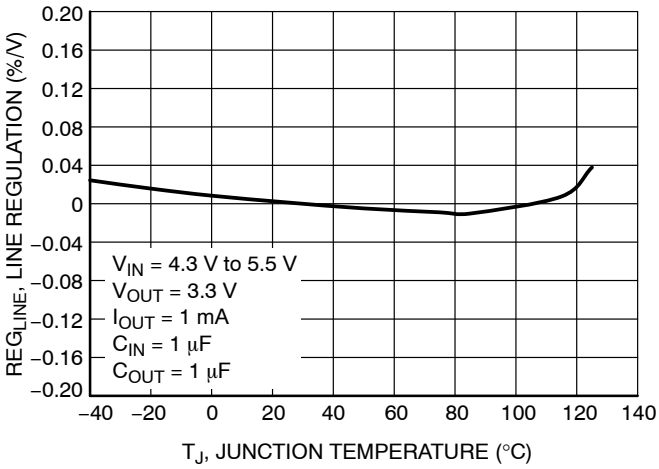

Figure 7. Line Regulation vs. Temperature

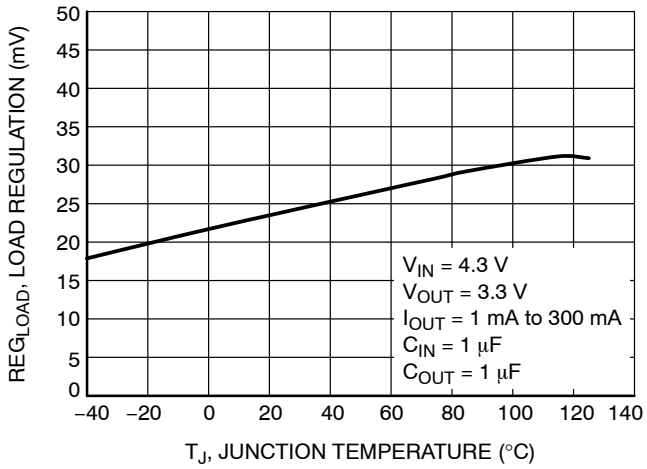

Figure 8. Load Regulation vs. Temperature

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TYPICAL CHARACTERISTICS

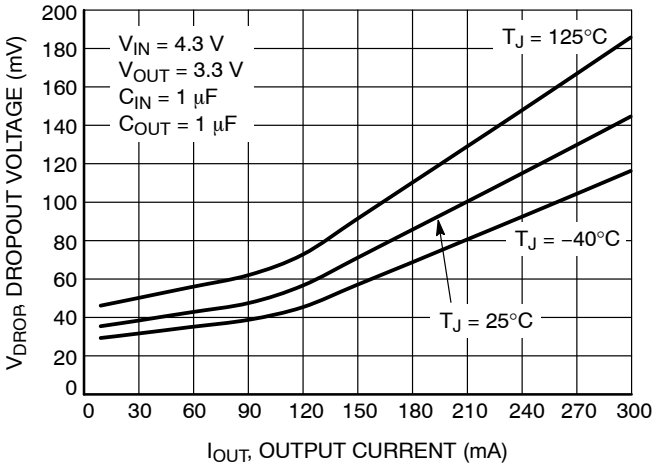

Figure 9. Dropout Voltage vs. Output Current

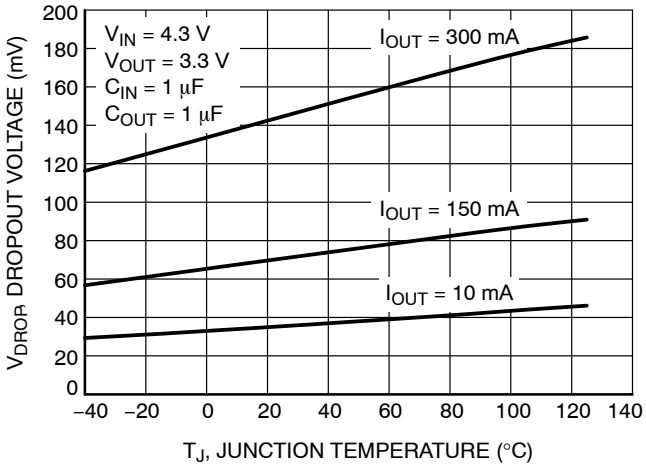

Figure 10. Dropout Voltage vs. Temperature

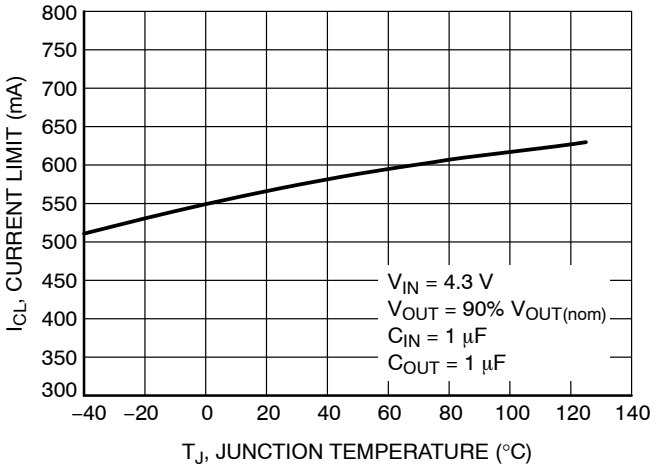

Figure 11. Current Limit vs. Temperature

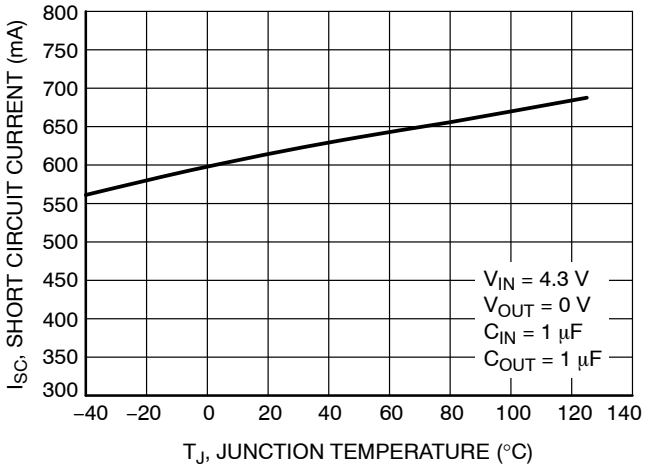

Figure 12. Short Circuit Current vs. Temperature

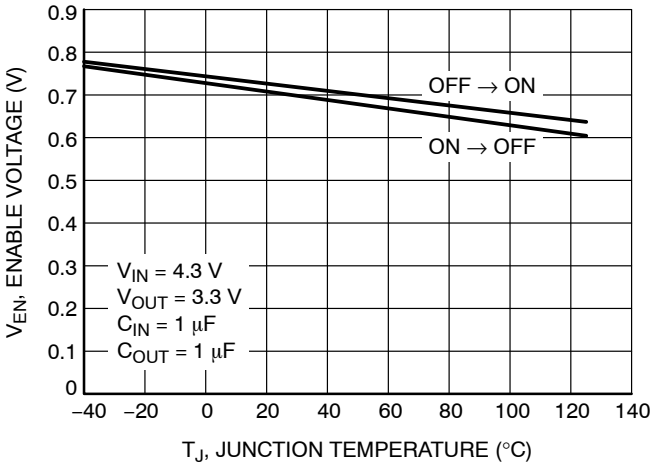

Figure 13. Enable Voltage Threshold vs. Temperature

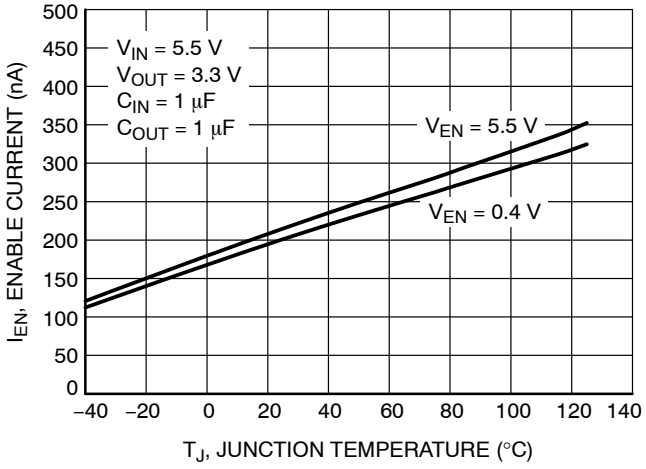

Figure 14. Current to Enable Pin vs. Temperature

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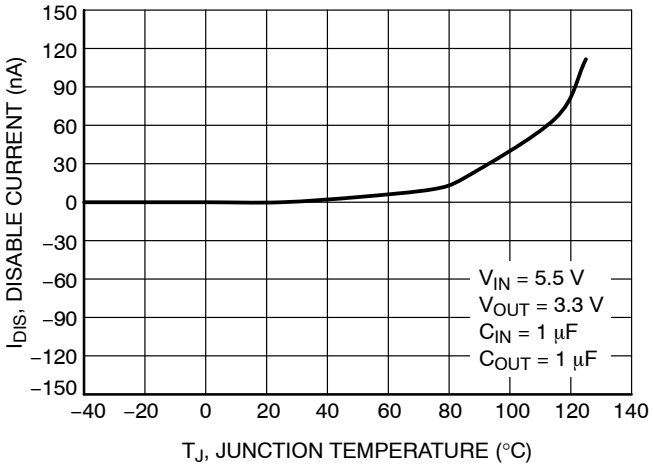


Figure 15. Disable Current vs. Temperature

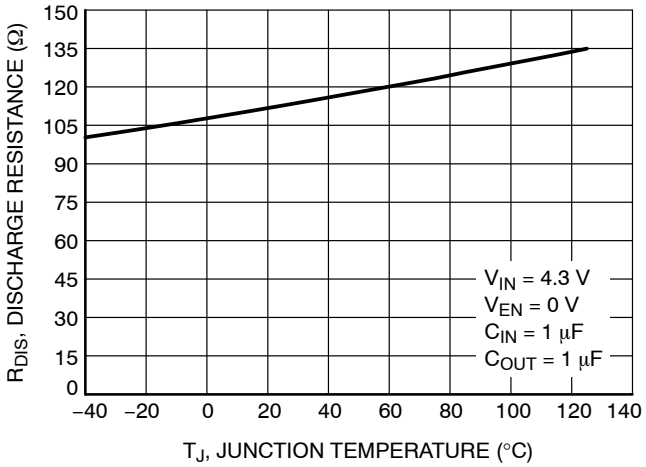


Figure 16. Discharge Resistance vs. Temperature

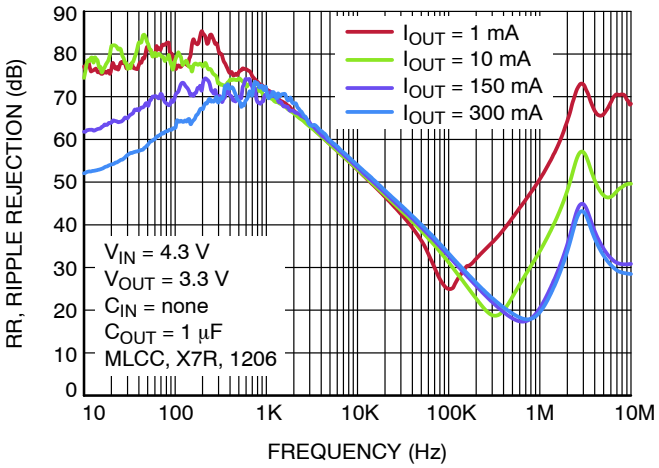


Figure 17. Power Supply Rejection Ratio – C_{OUT} = 1 μF

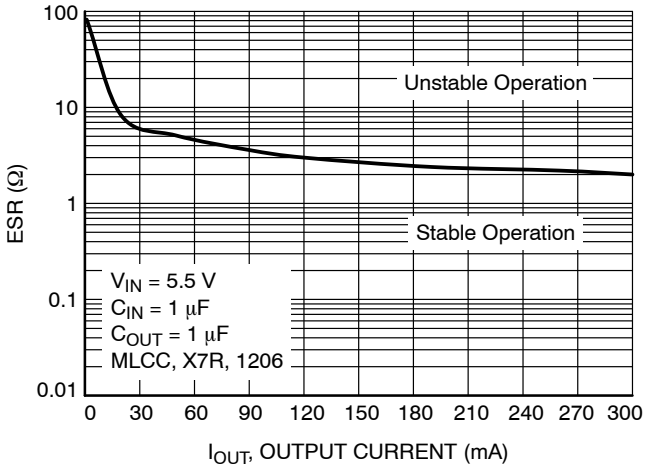
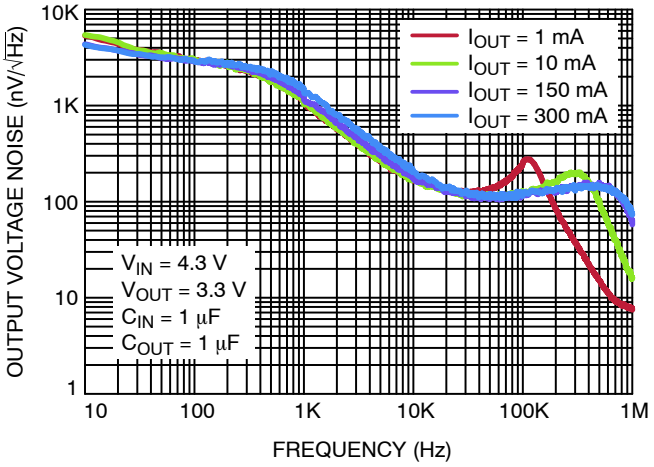


Figure 18. Output Capacitor ESR vs. Output Current



I_{OUT}	RMS Output Noise (μV)	
	10 Hz – 100 kHz	100 Hz – 100 kHz
1 mA	90.25	83.61
10 mA	84.55	77.23
150 mA	86.57	80.86
300 mA	95.36	90.17

Figure 19. Output Voltage Noise Spectral Density – C_{OUT} = 1 μF

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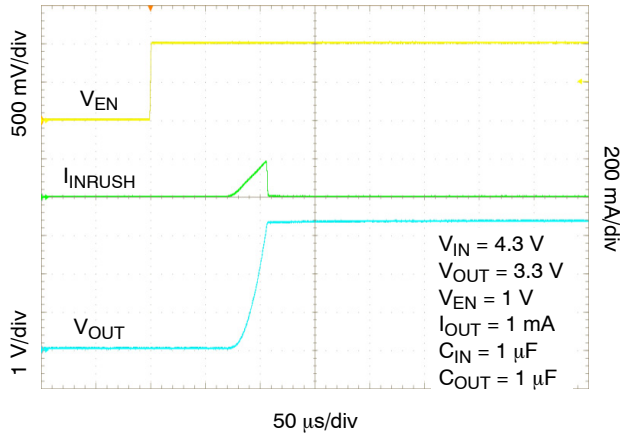

Figure 20. Enable Turn−on Response − C_{OUT} = 1 µF, I_{OUT} = 1 mA

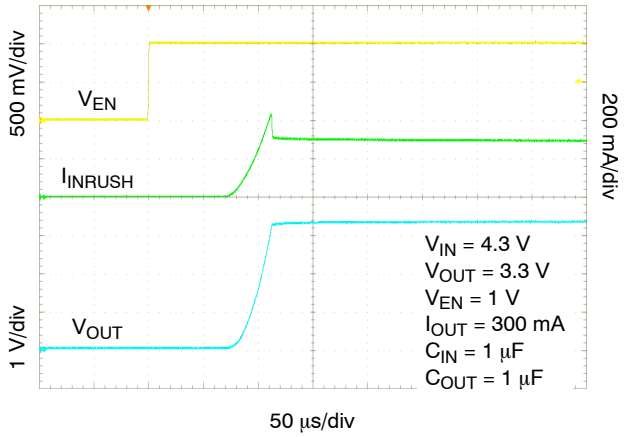

Figure 21. Enable Turn−on Response − C_{OUT} = 1 µF, I_{OUT} = 300 mA

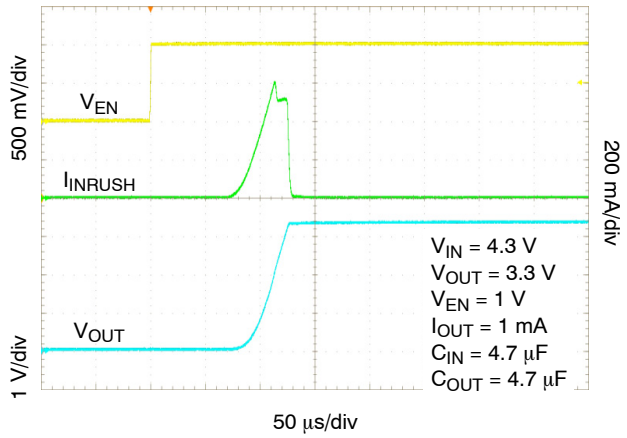

Figure 22. Enable Turn−on Response − C_{OUT} = 4.7 µF, I_{OUT} = 1 mA

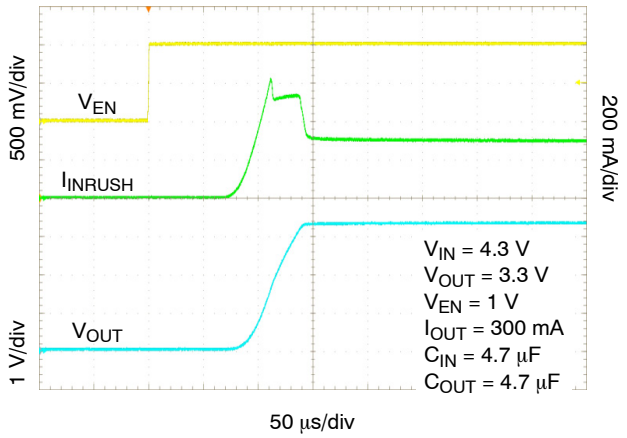

Figure 23. Enable Turn−on Response − C_{OUT} = 4.7 µF, I_{OUT} = 300 mA

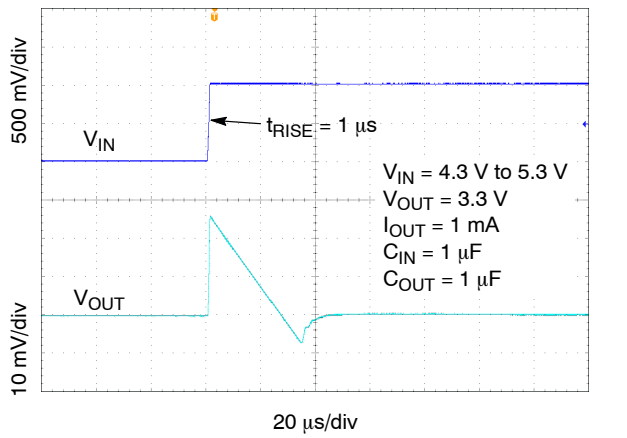

Figure 24. Line Transient Response − Rising Edge, I_{OUT} = 1 mA

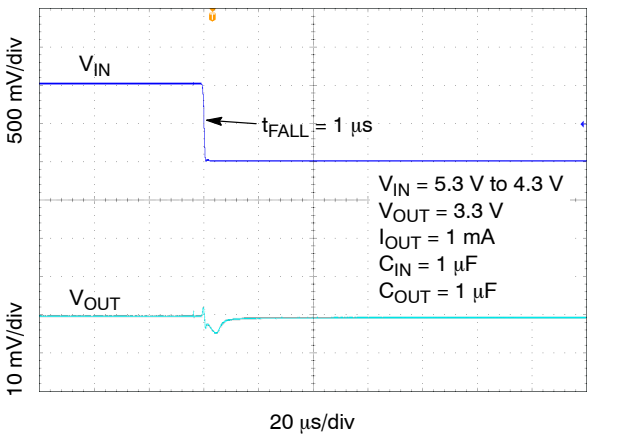

Figure 25. Line Transient Response − Falling Edge, I_{OUT} = 1 mA

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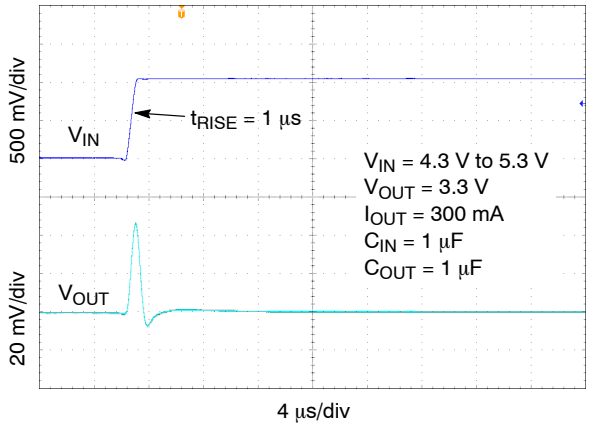

Figure 26. Line Transient Response – Rising Edge, I_{OUT} = 300 mA

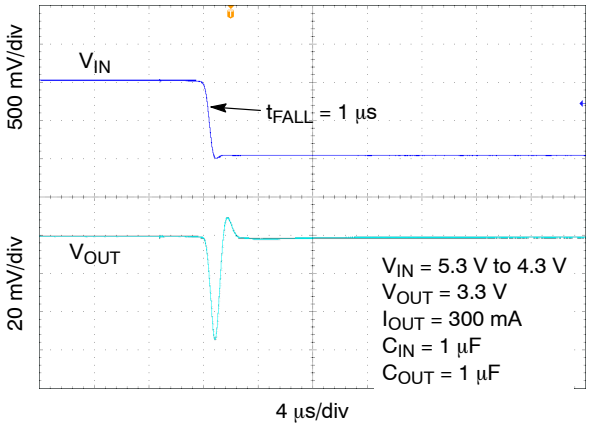

Figure 27. Line Transient Response – Falling Edge, I_{OUT} = 300 mA

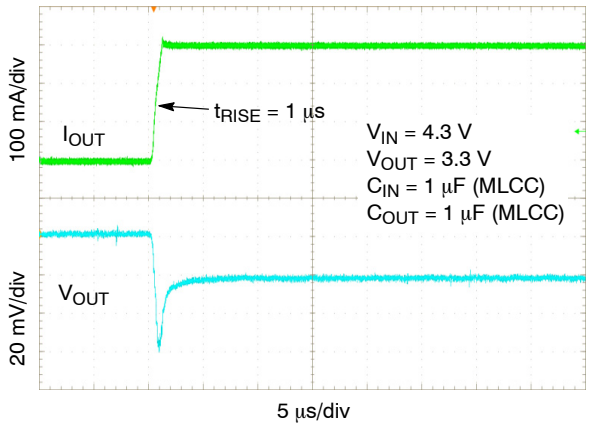

Figure 28. Load Transient Response – Rising Edge, V_{OUT} = 3.3 V, I_{OUT} = 1 mA to 300 mA

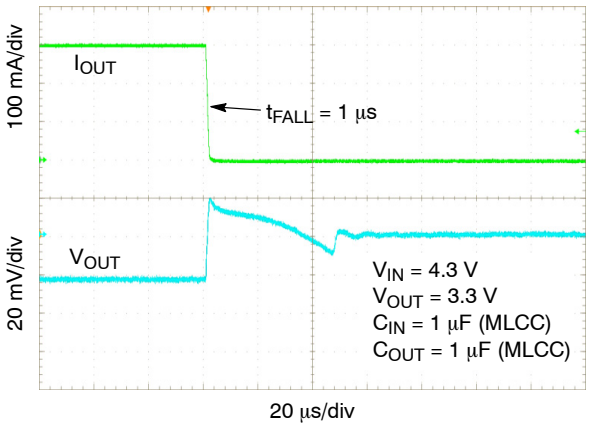

Figure 29. Load Transient Response – Falling Edge, V_{OUT} = 3.3 V, I_{OUT} = 1 mA to 300 mA

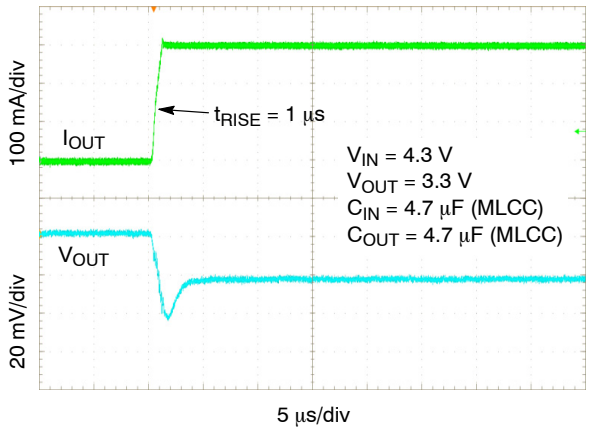

Figure 30. Load Transient Response – Rising Edge, V_{OUT} = 3.3 V, I_{OUT} = 1 mA to 300 mA

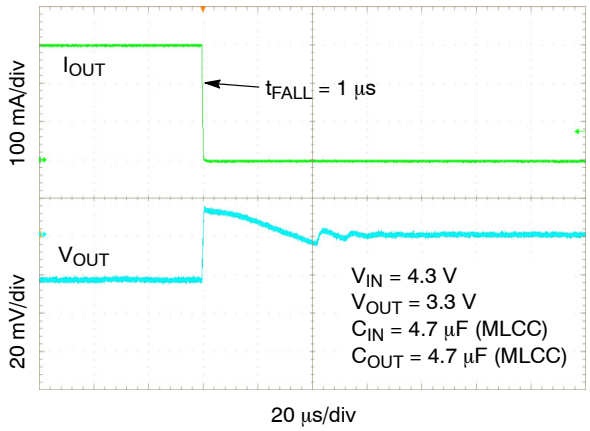

Figure 31. Load Transient Response – Falling Edge, V_{OUT} = 3.3 V, I_{OUT} = 1 mA to 300 mA

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TYPICAL CHARACTERISTICS

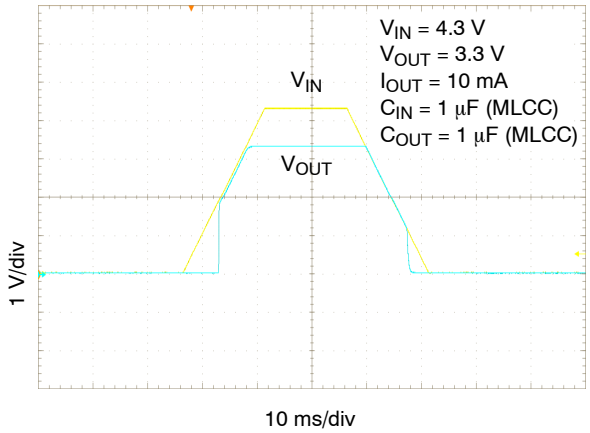

Figure 32. Turn−on/off − Slow Rising V_{IN}

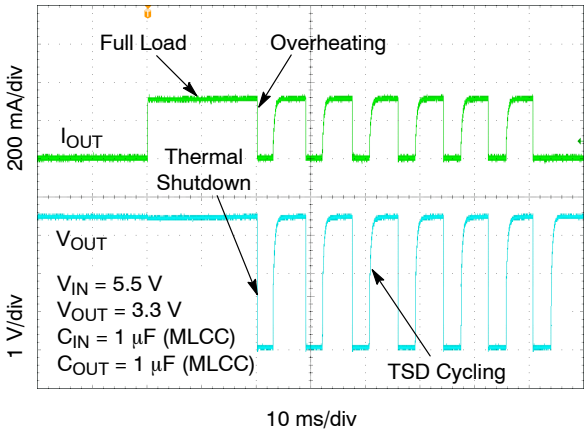

Figure 33. Short Circuit and Thermal Shutdown

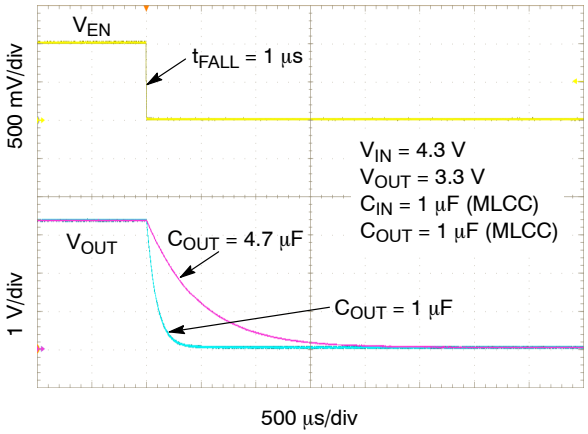

Figure 34. Enable Turn−off

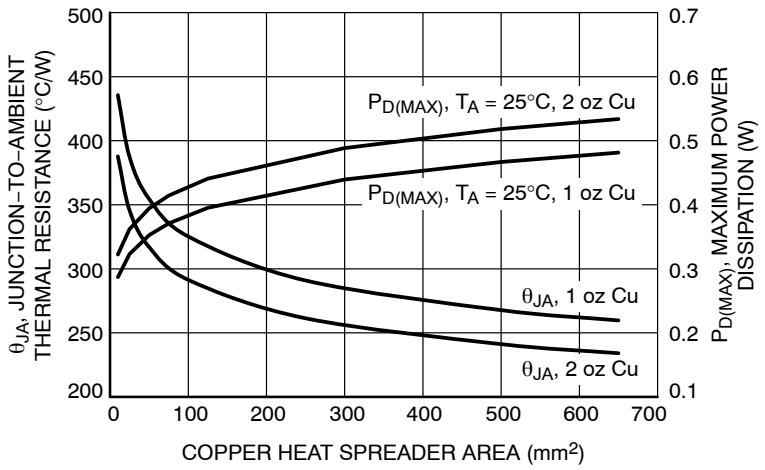

Figure 35.

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APPLICATIONS INFORMATION

General

The NCV8114 is a high performance 300 mA Low Dropout Linear Regulator. This device delivers very high PSRR (over 75 dB at 1 kHz) and excellent dynamic performance as load/line transients. In connection with very low quiescent current this device is very suitable for various battery powered applications such as tablets, cellular phones, wireless and many others. The device is fully protected in case of output overload, output short circuit condition and overheating, assuring a very robust design.

Input Capacitor Selection (C_{IN})

It is recommended to connect at least a 1 μF Ceramic X5R or X7R capacitor as close as possible to the IN pin of the device. This capacitor will provide a low impedance path for unwanted AC signals or noise modulated onto constant input voltage. There is no requirement for the min. /max. ESR of the input capacitor but it is recommended to use ceramic capacitors for their low ESR and ESL. A good input capacitor will limit the influence of input trace inductance and source resistance during sudden load current changes. Larger input capacitor may be necessary if fast and large load transients are encountered in the application.

Output Decoupling (C_{OUT})

The NCV8114 requires an output capacitor connected as close as possible to the output pin of the regulator. The recommended capacitor value is 1 μF and X7R or X5R dielectric due to its low capacitance variations over the specified temperature range. The NCV8114 is designed to remain stable with minimum effective capacitance of 0.22μF to account for changes with temperature, DC bias and package size. Especially for small package size capacitors such as 0402 the effective capacitance drops rapidly with the applied DC bias.

There is no requirement for the minimum value of Equivalent Series Resistance (ESR) for the C_{OUT} but the maximum value of ESR should be less than 2 Ω. Larger output capacitors and lower ESR could improve the load transient response or high frequency PSRR. It is not recommended to use tantalum capacitors on the output due to their large ESR. The equivalent series resistance of tantalum capacitors is also strongly dependent on the temperature, increasing at low temperature.

Enable Operation

The NCV8114 uses the EN pin to enable/disable its device and to deactivate/activate the active discharge function.

If the EN pin voltage is <0.4 V the device is guaranteed to be disabled. The pass transistor is turned−off so that there is virtually no current flow between the IN and OUT. The active discharge transistor is active so that the output voltage V_{OUT} is pulled to GND through a 100 Ω resistor. In the disable state the device consumes as low as typ. 10 nA from the V_{IN}.

If the EN pin voltage >0.9 V the device is guaranteed to be enabled. The NCV8114 regulates the output voltage and the active discharge transistor is turned−off.

The EN pin has internal pull−down current source with typ. value of 300 nA which assures that the device is turned−off when the EN pin is not connected. In the case where the EN function isn't required the EN should be tied directly to IN.

Output Current Limit

Output Current is internally limited within the IC to a typical 600 mA. The NCV8114 will source this amount of current measured with a voltage drops on the 90% of the nominal V_{OUT}. If the Output Voltage is directly shorted to ground (V_{OUT} = 0 V), the short circuit protection will limit the output current to 630 mA (typ). The current limit and short circuit protection will work properly over whole temperature range and also input voltage range. There is no limitation for the short circuit duration.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown threshold (T_{SD} − 160°C typical), Thermal Shutdown event is detected and the device is disabled. The IC will remain in this state until the die temperature decreases below the Thermal Shutdown Reset threshold (T_{SDU} − 140°C typical). Once the IC temperature falls below the 140°C the LDO is enabled again. The thermal shutdown feature provides the protection from a catastrophic device failure due to accidental overheating. This protection is not intended to be used as a substitute for proper heat sinking.

Power Dissipation

As power dissipated in the NCV8114 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. For reliable operation, junction temperature should be limited to +125°C.

The maximum power dissipation the NCV8114 can handle is given by:

$$P_{D(MAX)} = \frac{\left[125^{\circ}C - T_A\right]}{\theta_{JA}} \qquad \text{(eq. 1)}$$

The power dissipated by the NCV8114 for given application conditions can be calculated from the following equations:

$$P_D \approx V_{IN}\left(I_{GND}@I_{OUT}\right) + I_{OUT}\left(V_{IN} - V_{OUT}\right) \qquad \text{(eq. 2)}$$

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Reverse Current

The PMOS pass transistor has an inherent body diode which will be forward biased in the case that $V_{OUT} > V_{IN}$. Due to this fact in cases, where the extended reverse current condition can be anticipated the device may require additional external protection.

Power Supply Rejection Ratio

The NCV8114 features very good Power Supply Rejection ratio. If desired the PSRR at higher frequencies in the range 100 kHz – 10 MHz can be tuned by the selection of C_{OUT} capacitor and proper PCB layout.

Turn−On Time

The turn−on time is defined as the time period from EN assertion to the point in which V_{OUT} will reach 98% of its nominal value. This time is dependent on various application conditions such as $V_{OUT(NOM)}$, C_{OUT} and T_A. For example typical value for V_{OUT} = 1.2 V, C_{OUT} = 1 μF, I_{OUT} = 1 mA and T_A = 25°C is 90 μs.

PCB Layout Recommendations

To obtain good transient performance and good regulation characteristics place C_{IN} and C_{OUT} capacitors close to the device pins and make the PCB traces wide. In order to minimize the solution size, use 0402 capacitors. Larger copper area connected to the pins will also improve the device thermal resistance. The actual power dissipation can be calculated from the equation above (Equation 2). Expose pad should be tied the shortest path to the GND pin.

ORDERING INFORMATION

Device	Voltage Option	Marking	Option	Package	Shipping†
NCV8114ASN120T1G	1.2 V	DEC	With output active discharge function	TSOP−5 (Pb−Free)	3000 / Tape & Reel (Contact sales office for availability)
NCV8114ASN165T1G	1.65 V	DEJ			
NCV8114ASN170T1G	1.7 V	DEK			
NCV8114ASN180T1G	1.8 V	DEE			
NCV8114ASN250T1G	2.5 V	DEH			
NCV8114ASN280T1G	2.8 V	DEF			
NCV8114ASN300T1G	3.0 V	DEG			
NCV8114ASN330T1G	3.3 V	DEA			
NCV8114BSN120T1G	1.2 V	DFC	Without output active discharge function		
NCV8114BSN180T1G	1.8 V	DFE			
NCV8114BSN330T1G	3.3 V	DFA			

DISCONTINUED (Note 6)

NCV8114ASN150T1G	1.5 V	DED	With output active discharge function	TSOP−5 (Pb−Free)	3000 / Tape & Reel (Contact sales office for availability)
NCV8114BSN150T1G	1.5 V	DFD	Without output active discharge function		
NCV8114BSN280T1G	2.8 V	DFF			
NCV8114BSN300T1G	3.0 V	DFG			

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

6. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

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ZigBee is a registered trademark of ZigBee Alliance.

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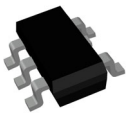
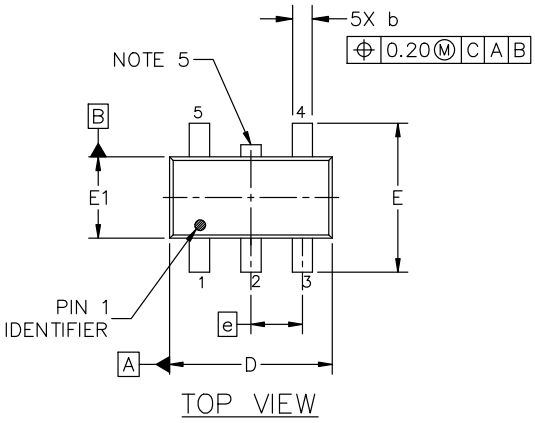
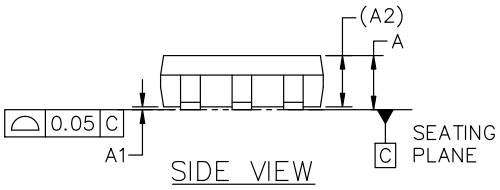


TSOP−5 3.00x1.50x0.95, 0.95P
CASE 483
ISSUE P

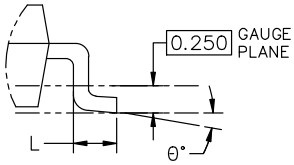
DATE 01 APR 2024



TOP VIEW



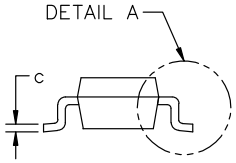
SIDE VIEW



DETAIL "A"
SCALE 2:1

NOTES:

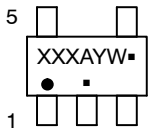
1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5−2018.
2. ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES).
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION D.
5. OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.



END VIEW

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.900	1.000	1.100
A1	0.010	0.055	0.100
A2		0.950 REF.	
b	0.250	0.375	0.500
c	0.100	0.180	0.260
D	2.850	3.000	3.150
E	2.500	2.750	3.000
E1	1.350	1.500	1.650
e		0.950 BSC	
L	0.200	0.400	0.600
θ	0°	5°	10°

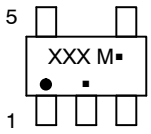
GENERIC
MARKING DIAGRAM*



Analog

XXX = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week
▪ = Pb−Free Package

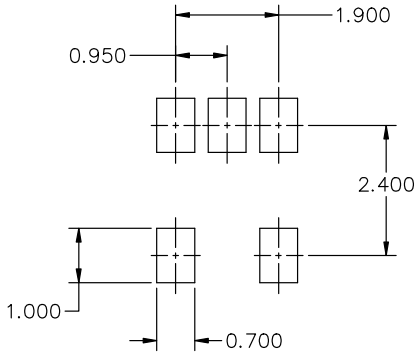
(Note: Microdot may be in either location)



Discrete/Logic

XXX = Specific Device Code
M = Date Code
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT*

* FOR ADDITIONAL INFORMATION ON OUR Pb−FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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